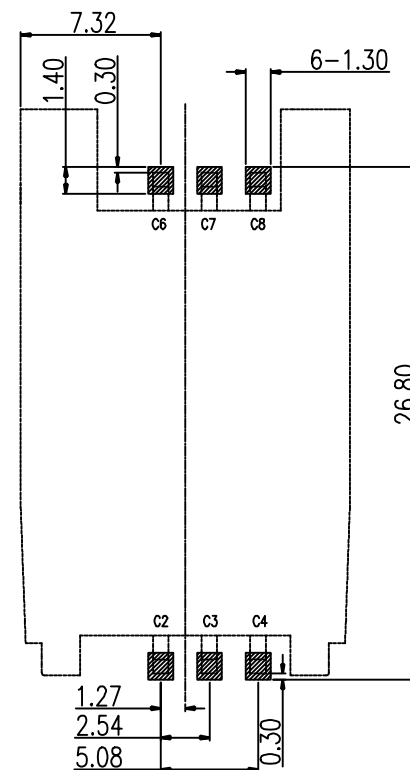
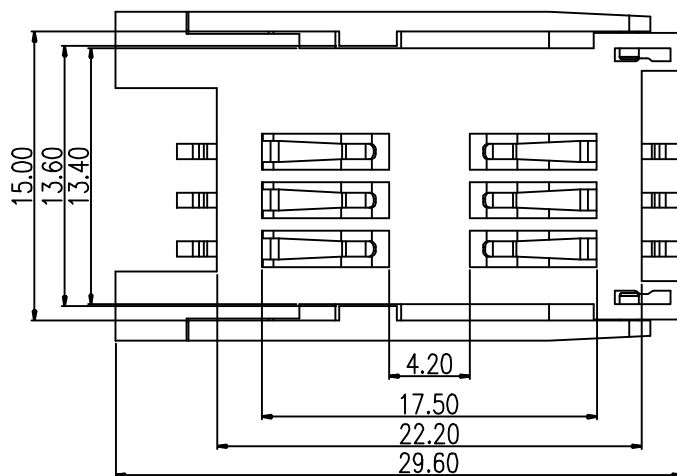
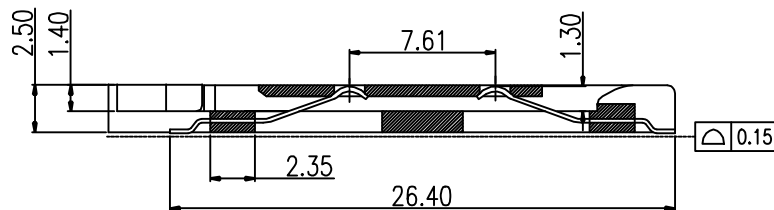
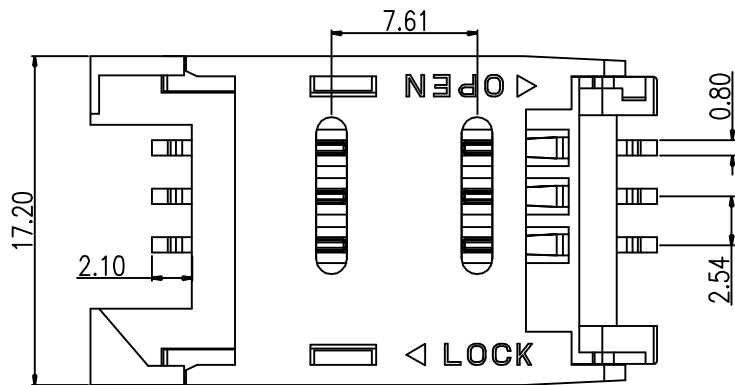


REV.	ECN.NO.	MODIFY.CONTENT	DATE
A		NEW	2015/03/20



- A.Material:
- 1.Insulator:High temperature thermoplastic UL94V-0,(BLACK LCP)
 - 2.Pho.Bronze:Plating, 50U" MIN NICKEL UNDERPLATED; 3-8U" GOLD ON THE CONTACT AREA; 100U" TIN PLATING ON SOLDER TAIL
- B.Electrical specifications:
- Voltage rating: 10 V AC
 - Current rating: 0.5A
 - Dielectric strength: 500V AC for 1 minute min
 - Insulation resistance: 1000 M ohm
 - Contact resistance: 100 mill.ohm max
 - Operation temperature: -25t to +95t
 - Product withstanding rff low soldering 260t for 10s
- C.Mechanical speicieations:
- 3.1 Durability: 5000 cycles

RECOMMENDED PCB PATTERN DIM.

TOLERANCE : ± 0.05

GENERAL TOLERANCE		DWG NO.	LZA0725-001	APPD:	WIND	Scale	1:1
X. ± 0.45	x.' ± 5 '	Title	2.5H 6PIN SIM CARD SMT Conn.	CHKD:		UNIT	mm
.X ± 0.35	.x' ± 2 '			DR:			
.XX ± 0.25	.xx' ± 1 '	Part NO.	ASMFS250A01BR135	Date	2015/03/20		
.XXX ± 0.15	.xxx' ± 0.5 '	东莞市捷圣泰电子科技有限公司 Dongguan JASSTA Electronics Co.,LTD					
SHEET	1/1						